

Engineering Tripos Part IIB, 4B28: Very large scale integration (VLSI), 2026-27

Leader

[Dr M Tang](#) [1]

Lecturer

[Dr M Tang](#) [1]

Timing and Structure

Michaelmas term. 75% exam / 25% coursework

Prerequisites

3B2 assumed, 3B5 useful.

Aims

The aims of the course are to:

- provide fundamental knowledge and analytical skills required for VLSI systems design in the nanometre era
- illustrate the importance of custom design tools and also electronic design automation (EDA) for physical implementation, testing and verifications of VLSI systems

Objectives

As specific objectives, by the end of the course students should be able to:

- be familiar with the modern CMOS fabrication process, physical layout design rules and anticipate trends in VLSI fabrication technologies
- understand the trade-off between the four key design metrics of modern VLSI systems – cost, reliability, speed and power
- recognise the parasitic effect of wires/interconnects and apply wire delay models like lumped RC model and Elmore delay model
- understand the sources of power dissipation and the factors affecting robustness of a VLSI system
- design and optimise multi-level CMOS combinational and sequential circuits using static logic, pass transistor logic and dynamic logic
- operate up-to-date design tools for VLSI systems and evaluate the quality of the outputs (e.g. floorplan, placement, routing, verification, etc.)

Content

The module will introduce the design principles of integrated circuit designs with millions of digital devices. It begins with CMOS design flows and fabrication processes that creates modern VLSI and explains the design metrics (performance, power, cost, reliability). The typical combinational and sequential circuit design styles like static logic, pass transistor logic and dynamic logic will be illustrated with many examples of digital devices. The effect of wires

and interconnects on circuit speed and power will be studied. The module will be concluded with a case study of cutting-edge advanced VLSI technologies (e.g. FinFET) and design techniques.

Design Flow and Metrics (1L)

- Design flow: design, synthesis, planning, implementation, fabrication
- Cost: yield and defects of wafer die
- Reliability: noise margins, regenerative property of digital circuits
- Speed: delay definition, Fanout-of-four (FO4) delay
- Power: instantaneous, average, peak

CMOS Fabrication and Layout Design Rules (1L)

- Fabrication process: substrate preparation, photolithography, doping and diffusion, oxidation, packing
- Design rules: micron rules vs scalable rules, CMOS process layers, stick diagrams (sketch)

CMOS inverters and static gates (2L)

- CMOS I-V equations, velocity saturation in deep sub-micron devices
- Source and model of parasitic capacitances
- DC analysis of CMOS inverters
- Equivalent resistance model
- Logic gate design using switch model

Wires and Interconnects (1L)

- Interconnect parameters: capacitance, resistance and inductance
- Wire models: lumped model, lumped RC model, Elmore delay model
- Distributed RC line

High-speed Logic Design and Logical Effort (1L)

- Delay of logic gates
- Derivation of intrinsic delay and logic effort
- Optimisation for buffer sizing and the number of buffer stages
- Branching Effort

CMOS Sequential Circuit Design, Clocking (2L)

- Static latches, flip-flops, and registers
- Dynamic designs: C²MOS register and TSPC latch
- Clock tree and clocking strategies

Electronic Design Automation (EDA) tools for VLSI (1L)

- Synthesis: logic circuit modelling, timing models
- Placement: principles and challenges
- Routing: principles and challenges

Power and Robustness (1L)

- Dynamic power dissipation
- Static consumption
- Power analysis and optimisation technique
- Signal integrity issues

Packaging, I/O and Electrostatic Discharge Protection (1L)

- Common VLSI packaging options and issues
- Input and output (I/O) pad and buffer design
- Tri-state buffers

Advanced VLSI Technology and Design Techniques (e.g. FinFET, 3D stacking) (1L)

- Topics varies every year, *suggestions from students are welcome.*

Coursework

Students are provided with a reference design in hardware description language (VHDL, Verilog or SystemVerilog), for instance an Arithmetic and Logic Unit (ALU) circuit. They will be asked to complete the semi-automatic design flow based on up-to-date Process Design Kit (PDK). During the process, they will be instructed to inspect and analyse results and reports from the various design automation tools. They may be able to verify the final physical layout of the reference design.

This activity involves preliminary work (~2h). You are required to read the lab handouts before lab sessions and be familiar with the usage of various design tools for this activity.

A total of 16 hours (including preliminary work) is required to complete this coursework.

Students will have the option to submit a Full Technical Report.

Submission and Assessment

The student will be asked to submit a technical report that summarises the experimental procedures, results and personal reflections on the lab exercises. In addition, the students will have to submit supporting documents (logbook, generated files, screen captures) as evidence of successful experiments.

Learning Objectives:

- Gain experience with VLSI/ASIC design tools (e.g. Cadence design tools)
- Practise a semi-custom design flow for VLSI/ASIC (synthesis, floorplan, place and routing, timing analysis)
- Verify a physical design (optional)

Booklists

- (Core) Analysis and design of digital integrated circuits: in deep submicron technology, David A. Hodges, Horace G. Jackson, Resve A. Saleh., 3rd ed, ISBN: 0072283653
- (Recommended) Rabaey, Chandrakasan and Nikolic, Digital Integrated Circuits, 2nd ed, ISBN-13: 978-0130909961
- (Recommended) Weste and Harris, CMOS VLSI Design, 4th ed, ISBN-13: 978-0321547743

Examination Guidelines

Please refer to [Form & conduct of the examinations](#) [2].

Last modified: 05/06/2026 10:39

Source URL (modified on 05-06-26): <https://teaching26-27.eng.cam.ac.uk/content/engineering-tripos-part-iib-4b28-very-large-scale-integration-vlsi-2026-27>

Links

[1] <mailto:wct26@cam.ac.uk>

[2] <https://teaching26-27.eng.cam.ac.uk/content/form-conduct-examinations>